RENESAS

BB505C

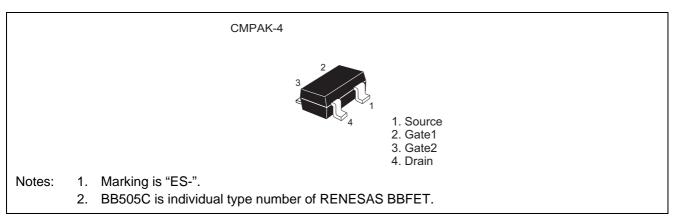
Build in Biasing Circuit MOS FET IC UHF RF Amplifier

REJ03G0364-0100Z Rev.1.00 Jun.14.2004

Features

- Build in Biasing Circuit; To reduce using parts cost & PC board space.
- Low noise; NF = 1.5 dB typ. at f = 900 MHz
- High gain; PG = 24 dB typ. at f = 900 MHz
- Withstanding to ESD;
 Build in ESD absorbing diode. Withstand up to 190 V at C = 200 pF, Rs = 0 conditions.
- Provide mini mold packages; CMPAK-4 (SOT-343mod)

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DS}	6	V
Gate1 to source voltage	V _{G1S}	+6	V
		-0	
Gate2 to source voltage	V _{G2S}	+6	V
		-0	
Drain current	ID	20	mA
Channel power dissipation	Pch ^{note3}	250	mW
Channel temperature	Tch	150	٥C
Storage temperature	Tstg	-55 to +150	۵°

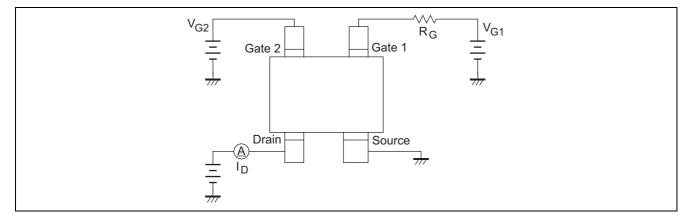
Notes: 3. Value on the glass epoxy board (50 mm \times 40 mm \times 1 mm).



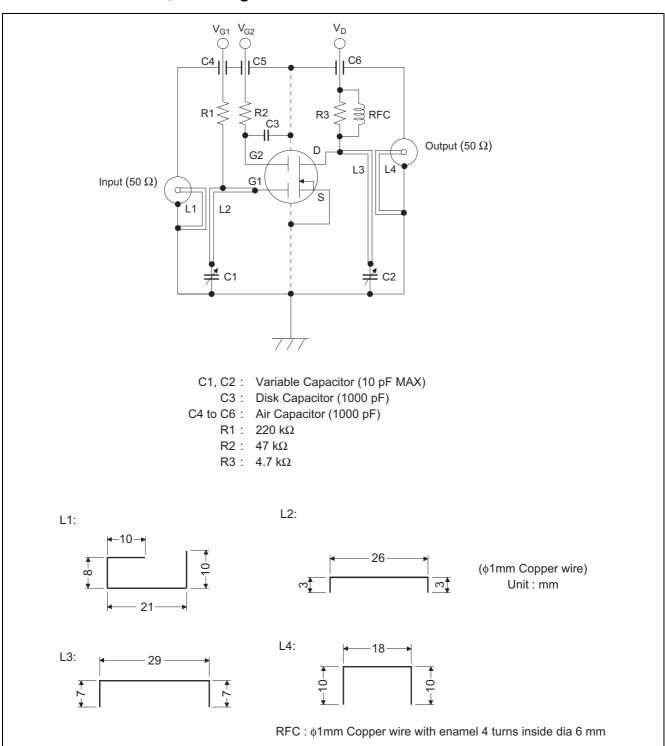
Electrical Characteristics

						$(Ta = 25^{\circ}C)$	
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions	
Drain to source breakdown voltage	V _{(BR)DSS}	6	—	—	V	$I_D = 200 \ \mu A, \ V_{G1S} = V_{G2S} = 0$	
Gate1 to source breakdown voltage	V _{(BR)G1SS}	+6	—	_	V	I_{G1} = +10 µA, V_{G2S} = V_{DS} = 0	
Gate2 to source breakdown voltage	V _{(BR)G2SS}	+6	—	_	V	I_{G2} = +10 µA, V_{G1S} = V_{DS} = 0	
Gate1 to source cutoff current	I _{G1SS}	_	—	+100	nA	$V_{G1S} = +5 V, V_{G2S} = V_{DS} = 0$	
Gate2 to source cutoff current	I _{G2SS}		—	+100	nA	$V_{G2S} = +5 V, V_{G1S} = V_{DS} = 0$	
Gate1 to source cutoff voltage	V _{G1S(off)}	0.5	0.7	1.0	V	$V_{DS} = 5 \text{ V}, V_{G2S} = 4 \text{ V}, I_D = 100 \mu\text{A}$	
Gate2 to source cutoff voltage	V _{G2S(off)}	0.5	0.7	1.0	V	$V_{DS} = 5 \text{ V}, V_{G1S} = 5 \text{ V}, I_D = 100 \mu\text{A}$	
Drain current	I _{D(op)}	7	11	15	mA	$V_{DS} = 5 \text{ V}, \text{ V}_{G1} = 5 \text{ V}, \text{ V}_{G2S} = 4 \text{ V}$ R _G = 220 kΩ	
Forward transfer admittance	y _{fs}	28	33	38	mS		
Input capacitance	C _{iss}	1.4	1.75	2.1	pF	$V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} = 4 V$	
Output capacitance	Coss	1.0	1.4	1.8	pF	$R_G = 220 \text{ k}\Omega, \text{ f} = 1 \text{ MHz}$	
Reverse transfer capacitance	Crss		0.03	0.05	pF		
Power gain	PG	19	24	29	dB	$V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} = 4 V$	
Noise figure	NF		1.5	2.2	dB	R _G = 220 kΩ, f = 900 MHz	

Bias Circuit for Operating Items ($I_{D(op)}$, $|y_{fs}|$, Ciss, Coss, Crss, NF, PG)

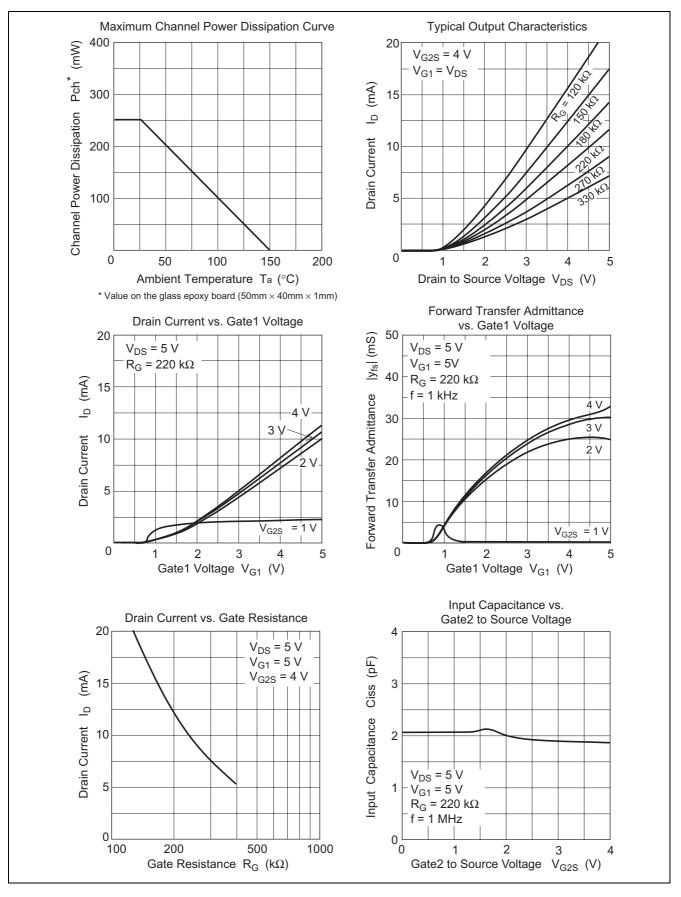




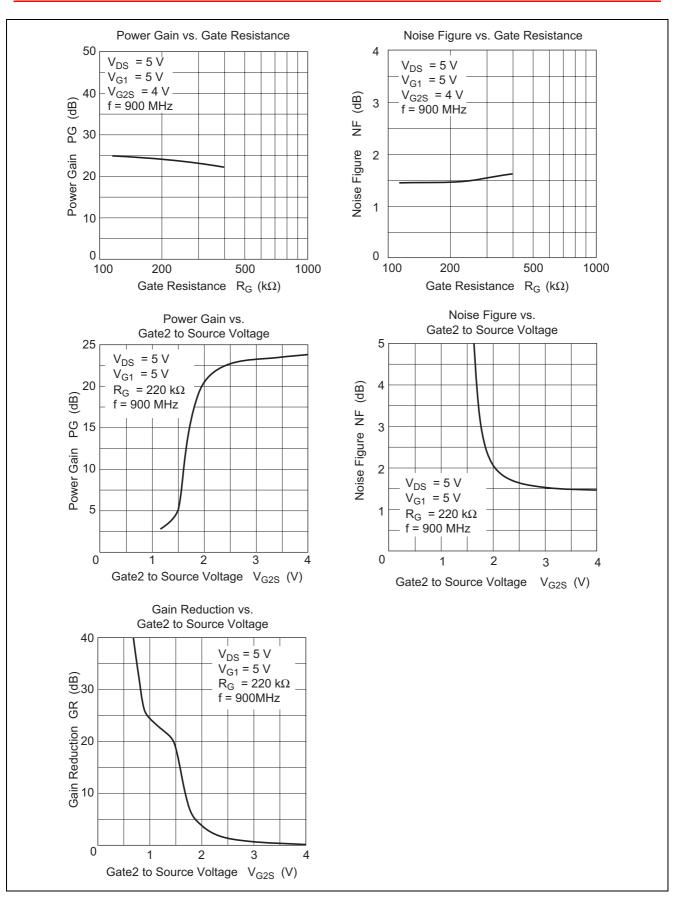


900 MHz Power Gain, Noise Figure Test Circuit

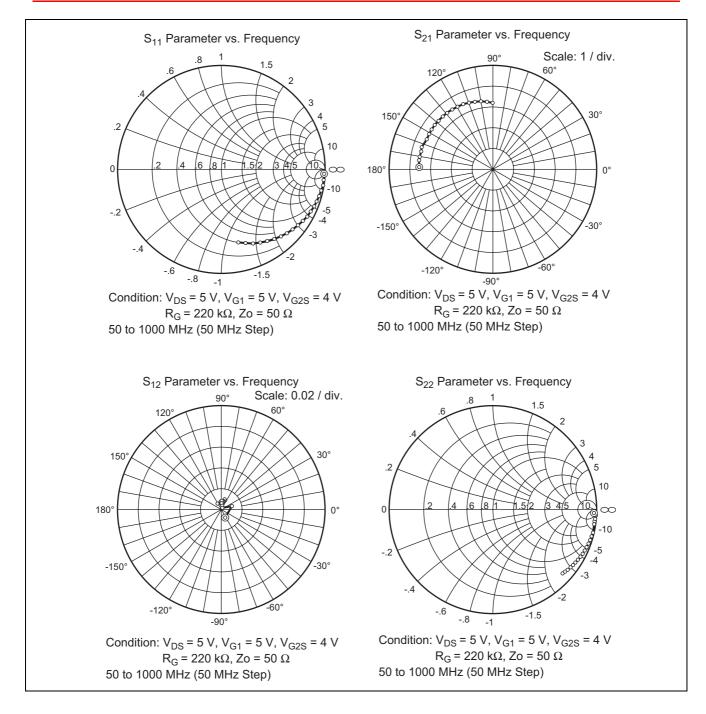
Main Characteristics













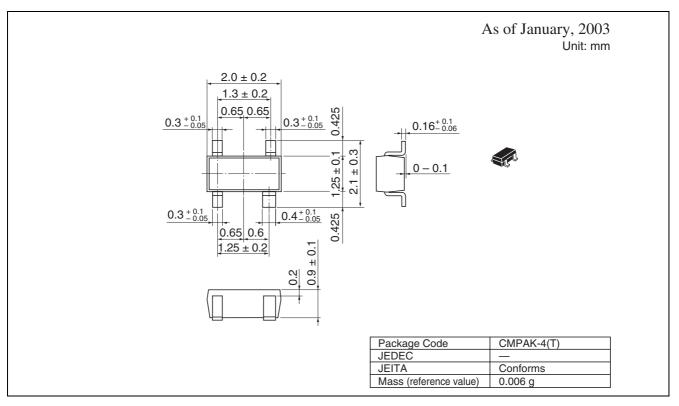
S parameter

$(V_{DS} = 5 V, V_{G1} = 5 V, V_{G2S} = 4 V$	V, $R_G = 200 \text{ k}\Omega$, $Z_O = 50 \Omega$)
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	S11		S21			S12		S22	
f (MHz)	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG	
50	0.991	-2.4	3.55	178.2	0.009	-64.5	0.976	-1.8	
100	0.991	-5.9	3.58	172.9	0.011	18.0	0.995	-3.1	
150	0.993	-8.9	3.58	170.2	0.002	61.4	0.990	-5.2	
200	0.983	-11.9	3.56	165.9	0.004	77.7	0.986	-6.5	
250	0.977	-15.3	3.59	162.6	0.006	87.6	0.986	-8.2	
300	0.969	-18.5	3.50	155.5	0.008	87.8	0.990	-12.9	
350	0.962	-21.6	3.51	151.0	0.006	94.6	0.984	-15.1	
400	0.952	-25.2	3.52	146.9	0.007	80.9	0.982	-17.3	
450	0.944	-28.7	3.52	142.6	0.008	87.1	0.977	-19.5	
500	0.929	-32.2	3.51	138.2	0.008	78.1	0.973	-21.8	
550	0.914	-36.0	3.51	133.4	0.008	74.7	0.968	-24.0	
600	0.897	-40.0	3.50	129.0	0.008	84.8	0.963	-26.1	
650	0.881	-44.2	3.49	124.2	0.010	72.6	0.957	-28.2	
700	0.863	-48.3	3.47	119.4	0.010	67.5	0.950	-30.4	
750	0.842	-52.7	3.45	114.5	0.008	78.7	0.943	-32.6	
800	0.819	-57.3	3.41	109.7	0.008	82.1	0.939	-34.6	
850	0.797	-62.0	3.37	104.9	0.008	85.3	0.931	-36.6	
900	0.775	-66.8	3.33	99.9	0.008	95.6	0.924	-38.7	
950	0.746	-71.8	3.27	94.9	0.007	97.4	0.916	-40.6	
1000	0.721	-76.9	3.20	90.2	0.007	122.8	0.909	-42.4	



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
BB505CES-	3000	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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